

ON Semiconductor[®]

FCPF190N60-F152

N-Channel SuperFET[®] II MOSFET 600 V, 20.2 A, 199 m Ω

Features

- 650 V @T_J = 150°C
- Max. R_{DS(on)} = 199 mΩ
- Ultra low gate charge (typ. Q_g = 57 nC)
- Low effective output capacitance (typ. C_{oss}.eff = 160 pF)
- 100% avalanche tested

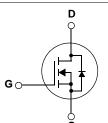
Description

SuperFET®II MOSFET is ON Semiconductor's first generation of high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resis-tance and lower gate charge performance. This advanced tech-nology is tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. Consequently, SuperFET®II MOSFET is suitable for various AC/DC power conversion for system minia-turization and higher efficiency.

Aplications

- LCD / LED / PDP TV Lighting
- Solar Inverter
- AC-DC Power Supply





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter Drain to Source Voltage			FCPF190N60-F152	Unit V	
V _{DSS}				600		
V _{GSS}	Gate to Source Voltage	-DC		±20	V	
		-AC	(f >1Hz)	±30	- V	
ID	Drain Current	-Continuous (T _C = 25 ^o C)		20.2*	Α	
		-Continuous (T _C = 100 ^o C)		12.7*		
I _{DM}	Drain Current	- Pulsed	(Note 1)	60.6*	А	
E _{AS}	Single Pulsed Avalanche Energy		(Note 2)	400	mJ	
I _{AR}	Avalanche Current		(Note 1)	4.0	А	
E _{AR}	Repetitive Avalanche Energy		(Note 1)	2.1	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)			20	V/ns	
	MOSFET dv/dt			100	V/ns	
P _D	Dower Dissinction	$(T_{C} = 25^{\circ}C)$		39	W	
	Power Dissipation	- Derate above 25°C		0.31	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

*Drain current limited by maximum junction temperature

Thermal Characteristics

Symbol	Parameter	FCPF190N60-F152	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	3.2		
$R_{\theta CS}$	Thermal Resistance, Case to Heat Sink (Typical)	0.5	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5		

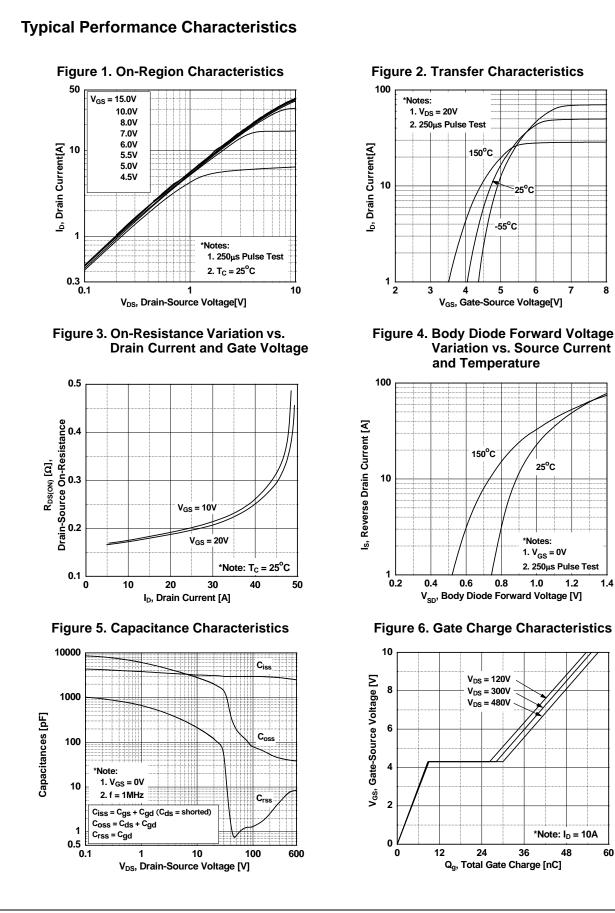
Publication Order Number: FCPF190N60-F152/D

Device Marking		Device	Package	Eco Status	Packaging	a Type	Qua	ntity
FCPF19	90N60	FCPF190N60-F152	TO-220F	Green 🥢	Tube		50	
Flectric	al Char	acteristics T _c = 25°C		notod				
Symbol		Parameter		Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	ctoristic					199.	max.	Unit
			$V_{CC} = 0V$	I _D = 10mA, T _J = 25°C	600	-	-	V
BV _{DSS}	Drain to	Source Breakdown Voltage		$I_{\rm D} = 10$ mA, $T_{\rm J} = 150^{\circ}$ C		-	-	V
∆BV _{DSS} ∆TJ	Breakdo	own Voltage Temperature		$I_D = 10$ mA, Referenced to 25°C		0.67	-	V/°C
BV _{DS}	Drain-So Voltage	ource Avalanche Breakdowr	$V_{GS} = 0V,$	I _D = 20A	-	700	-	V
		Voltage		$V_{DS} = 480V, V_{GS} = 0V$			10	
DSS	Zero Ga	Zero Gate Voltage Drain Current		$V_{\rm DS} = 480V, T_{\rm C} = 125^{\circ}{\rm C}$			10	μA
GSS	Gate to	Body Leakage Current		$V, V_{DS} = 0V$	-	-	±100	nA
On Charac		, ,	00					
/ _{GS(th)}		reshold Voltage	Voo = Vo	_S , I _D = 250μA	2.5	-	3.5	V
RDS(on)		rain to Source On Resistance		$V, I_D = 10A$	-	0.17	0.199	Ω
S S S S S S S S S S S S S S S S S S S		Transconductance		$V, I_D = 10A$	-	21	-	S
			103 20	.,				
Dynamic (apacitance			-	2220	2950	pF
Piss			V _{DS} = 25 ¹	V _{DS} = 25V, V _{GS} = 0V		2220		pr pF
C _{oss}		Capacitance Transfer Capacitance	f = 1MHz		-	1630 85	2165 128	pF pF
S _{rss}		Capacitance	V 38(V _{DS} = 380V, V _{GS} = 0V, f = 1MHz		42	120	pF
C _{oss} eff.		e Output Capacitance				160	_	pF
		te Charge at 10V	-	$V_{DS} = 0V \text{ to } 480V, V_{GS} = 0V$ $V_{DS} = 380V, I_D = 10A$ $V_{GS} = 10V$ (Note 4)		57	74	nC
ଦୁ _{g(tot)} ଦୁ _{gs}		Source Gate Charge				9	-	nC
		Drain "Miller" Charge	VGS - 10			21	-	nC
ຊ _{gd} ESR		ent Series Resistance	f = 1MHz			1	_	Ω
			1 - 110112			I	_	52
Switching					-		50	1
d(on)		Delay Time	V 29(V _{DD} = 380V, I _D = 10A		20	50	ns
r		Rise Time		$V, R_{\rm g} = 4.7\Omega$	-	10	30	ns
d(off)		Delay Time				64	138	ns
f		Fall Time		(Nc	- • • • • • • • • • • • • • • • • • • •	5	20	ns
	-	le Characteristics		-		1		
S		m Continuous Drain to Source			-	-	20.2	A
SM		n Pulsed Drain to Source Di	1		-	-	60.6	A
/ _{SD}		Source Diode Forward Volta		$V_{GS} = 0V, I_{SD} = 10A$		-	1.2	V
rr		Recovery Time	$V_{GS} = 0V_{IE}$, I _{SD} = 10A	-	280	-	ns
ג _{רר}	Reverse	Recovery Charge	$u_{\rm F}/u_{\rm I} = 10$	υσημο	-	3.8	-	μC

8

1.4

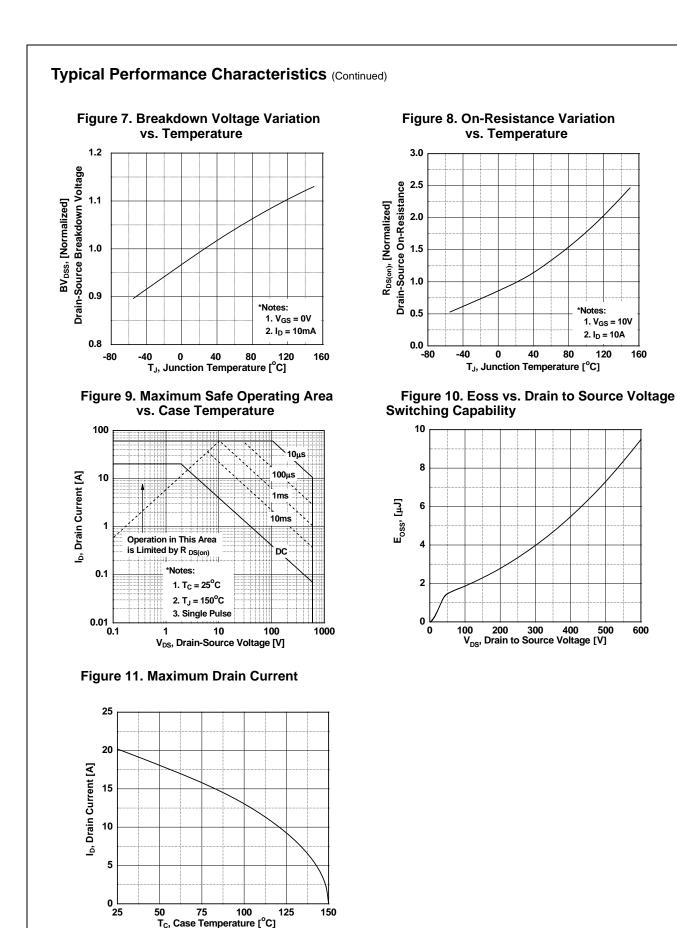
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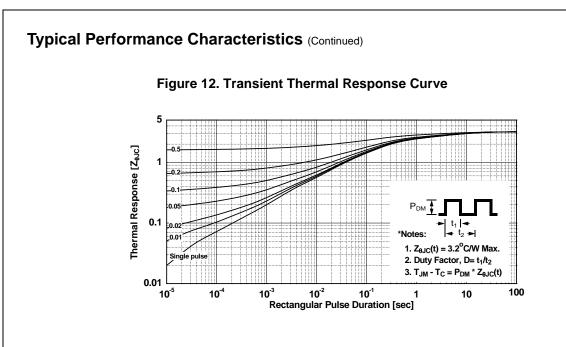
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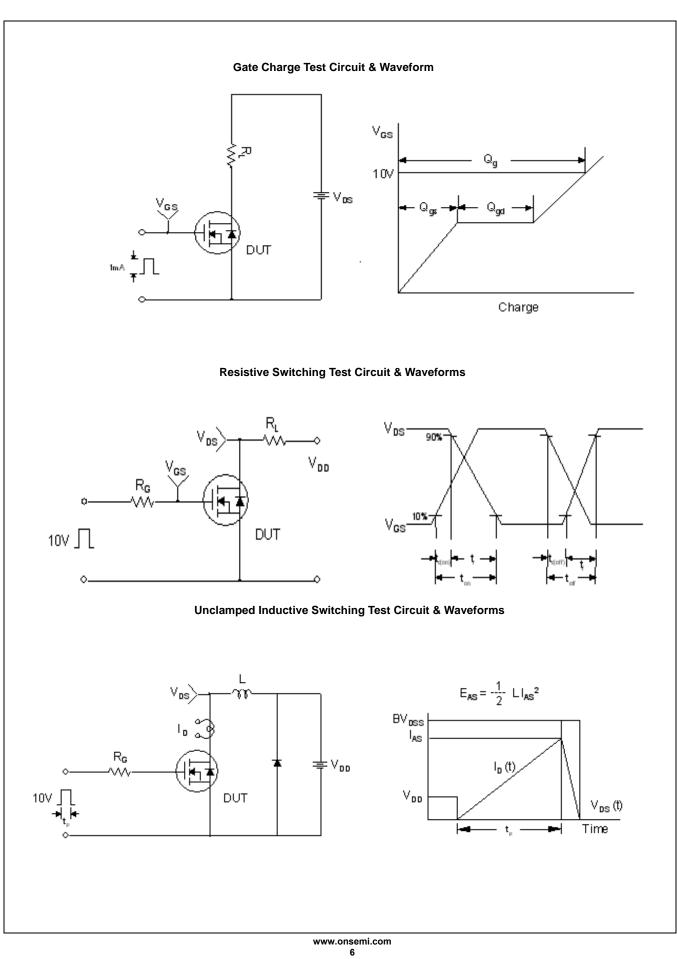
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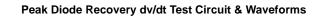
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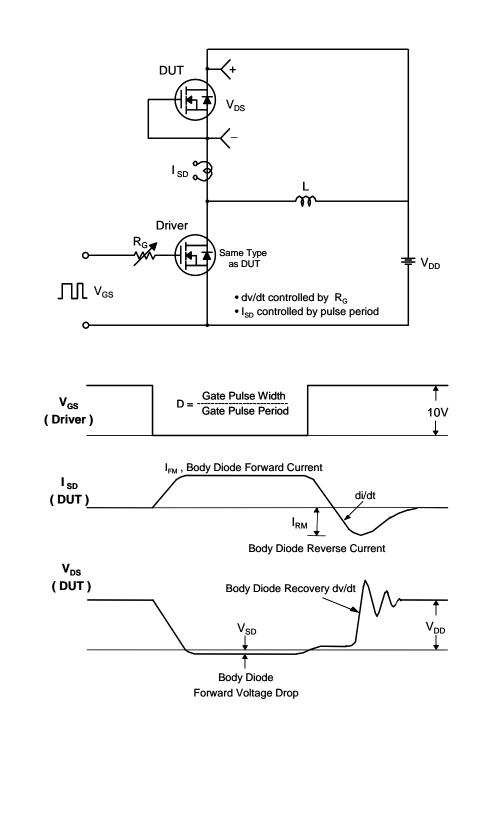


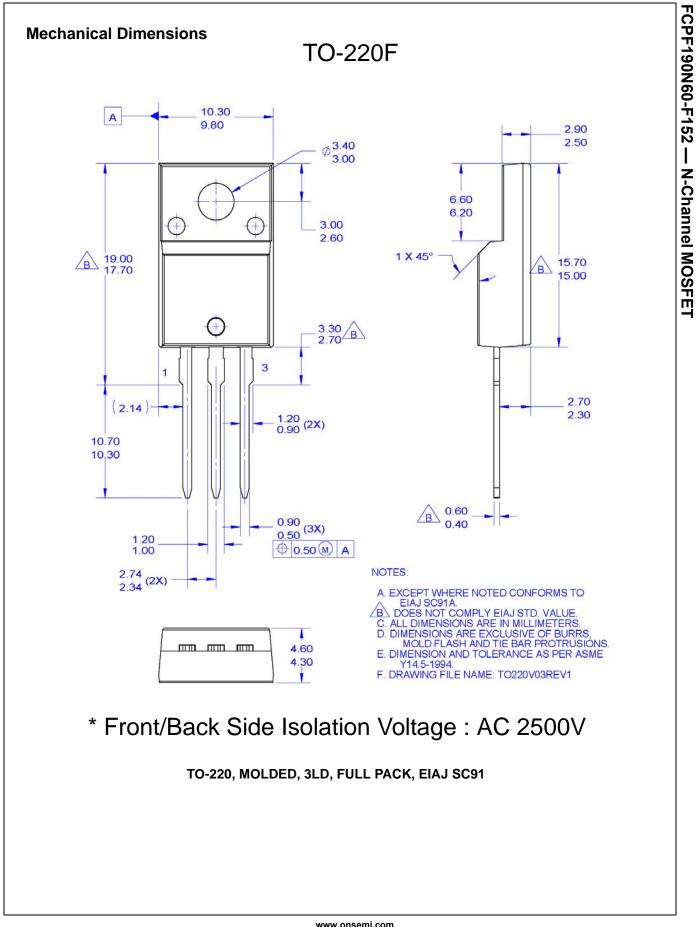
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